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IEEE R10 TENSYP 2027

12-14 May 2027 at the Faculty of Engineering, University of Peradeniya, Sri Lanka

Web : <https://tensymp27.ieee.lk/>

CALL FOR WORKSHOP PROPOSALS

Theme : Connected Intelligence for Resilient Societies

IEEE R10 TENSYP 2027 invites high-quality workshop proposals to be organized as part of the symposium programme. Workshops should provide focused, technically sound and practice-oriented engagement aligned with the theme, "Connected Intelligence for Resilient Societies". Proposals are welcome from researchers, IEEE members, academics, industry experts, professional bodies and cross-disciplinary teams.

Workshop Scope and Areas

Workshops may include invited talks, demonstrations, hands-on sessions, case studies and interactive Q&A sessions. Topics may include Artificial Intelligence, Machine Learning and Data Intelligence; Future Communication and Networking Technologies; Cyber-Physical Systems, IoT and Intelligent Automation; Sustainable Energy and Environmental Technologies; Cybersecurity, Privacy and Resilient Computing; Technology for Health, Humanity and Society; Ethics, Policy and Governance in Connected Systems; Education and Capacity Building; Smart Cities, Digital Twins and Resilient Infrastructure; Cloud, Edge and Distributed Computing; Industry 5.0, Digital Transformation and Humanitarian Technologies.

Workshop Format and Delivery Mode

Format	Duration	Delivery Mode
Half Day/ Full Day Workshop	3 Hours / 6 Hours	In Person or Online

Workshops may be conducted either as In-Person Workshops at the Faculty of Engineering, University of Peradeniya, Sri Lanka, or as Online Workshops through an approved virtual platform prior to the main conference dates. The final delivery mode will be determined based on proposal quality, relevance to the symposium theme and overall programme logistics.

Proposal Requirements

Workshop proposals should be submitted as a single PDF document, preferably not exceeding 6 pages, and should include: workshop title; preferred format and delivery mode; abstract; objectives; relevance to the conference theme; topics of interest; intended audience; tentative programme; organizer details and short biographies; proposed speakers or demonstrators, if any; expected number of participants; publicity plan; and technical or logistical requirements. If paper submissions are included, papers should follow the IEEE conference format and undergo peer review.

Submission and Enquiries

Workshop proposals must be submitted through the official submission system. The submission link will be announced on the TENSYP 2027 website. Please include "TENSYP 2027 Workshop Proposal" in the subject line of all email correspondence.

For enquiries, please contact:

Workshop Chair:

Prof. Anuradha Jayakody

Sri Lanka Institute of Information Technology, Sri Lanka

Email: anuradha.j@slit.lk

Join us in shaping a high-impact workshop programme that connects intelligent technologies with resilient societies.

IMPORTANT DATES

Workshop Proposal Submission Opens : 15 July 2026

Workshop Proposal Submission Deadline : 1 September 2026

Notification of Acceptance : 28 September 2026



Contact :

Conference Secretary:

Dr. Upul Jayasinghe,

University of Peradeniya, Sri Lanka

Email: tensymp27@eng.pdn.ac.lk

Organized by



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